

Title (en)

CHIP AND METHOD FOR FITTING OUT A CHIP COMPRISING A PLURALITY OF ELECTRODES

Title (de)

HALBLEITERCHIP UND VERFAHREN ZUR EINRICHTUNG EINES MIT EINER MEHRZAHL VON ELEKTRODEN VERSEHENEN HALBLEITERCHIPS

Title (fr)

PUCE ET PROCEDE DE GARNITURE D'UNE PUCE COMPRENANT UNE PLURALITE D'ELECTRODES

Publication

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Application

EP 00938870 A 20000531

Priority

- FR 0001506 W 20000531
- FR 9906949 A 19990602

Abstract (en)

[origin: FR2794572A1] A chip comprising a support (40, 44) and electrodes (20) which are disposed on a surface (14) of said support, a plurality of electric generators (22) which are integrated into said support and connected to a plurality of said electrodes. The generators can be activated by means of a light beam. The invention can be used for biological and chemical analyses.

IPC 1-7

H01L 27/142; G01N 33/487; G01N 33/00

IPC 8 full level

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CPC (source: EP US)

H01L 31/046 (2014.12 - EP US); **H10N 10/17** (2023.02 - EP US); **Y02E 10/50** (2013.01 - EP US); **Y10S 136/291** (2013.01 - EP US)

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